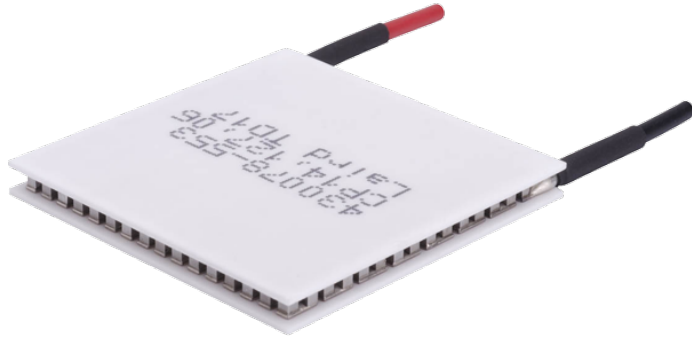


**Ceramic Plate Series Thermoelectric Cooler**

The CP14-127-06-L1-W4.5 is a high-performance and highly reliable standard Thermoelectric Cooler. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics. It has a maximum  $Q_c$  of 49.3 Watts when  $\Delta T = 0$  and a maximum  $\Delta T$  of 70.5 °C at  $Q_c = 0$ .

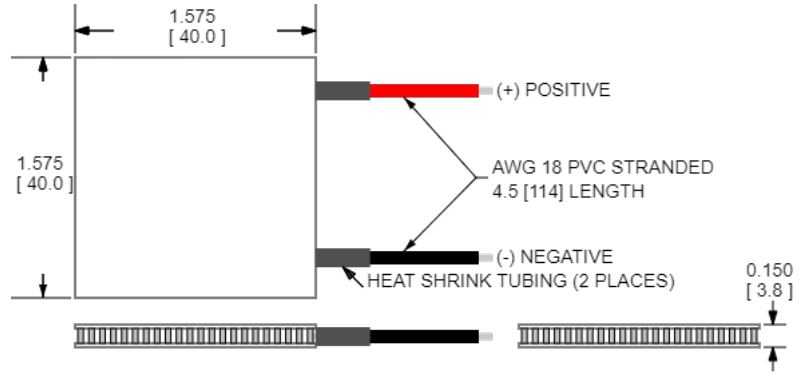


**Features**

- Compact geometric sizes
- DC Operation
- RoHS-compliant

**Applications**

- Thermoelectric Coolers for Reagent Storage
- Thermoelectric Coolers for Handheld Cosmetic Lasers
- Cooling for Centrifuges
- Heads-Up Displays, Imaging Sensors
- Peltier Cooling for Machine Vision

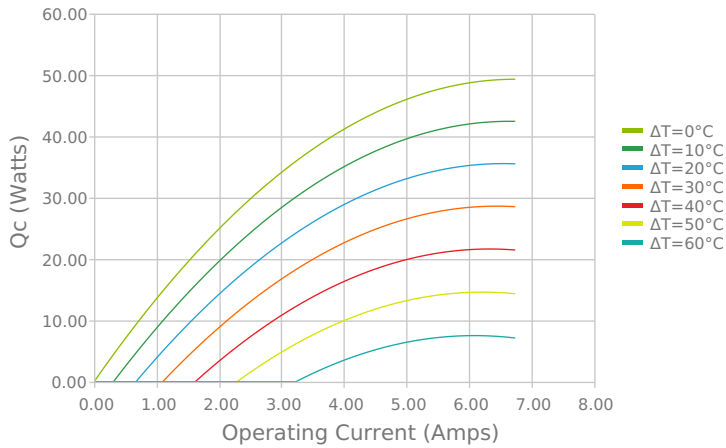


CERAMIC MATERIAL:  $Al_2O_3$   
 SOLDER CONSTRUCTION: 138°C, BiSn

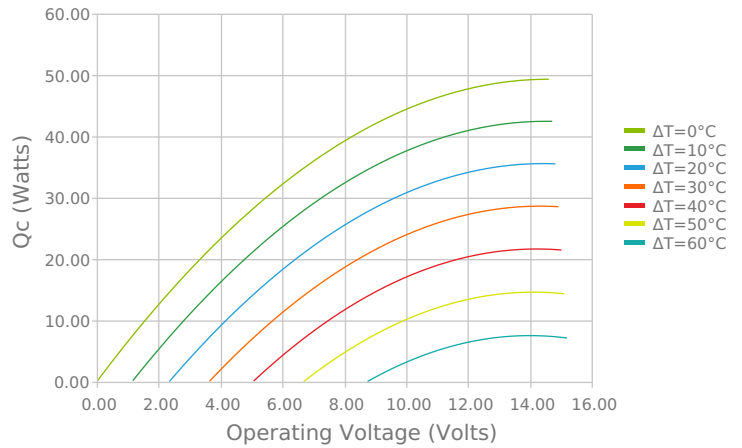
INCHES [ MM ]

**ELECTRICAL AND THERMAL PERFORMANCE**

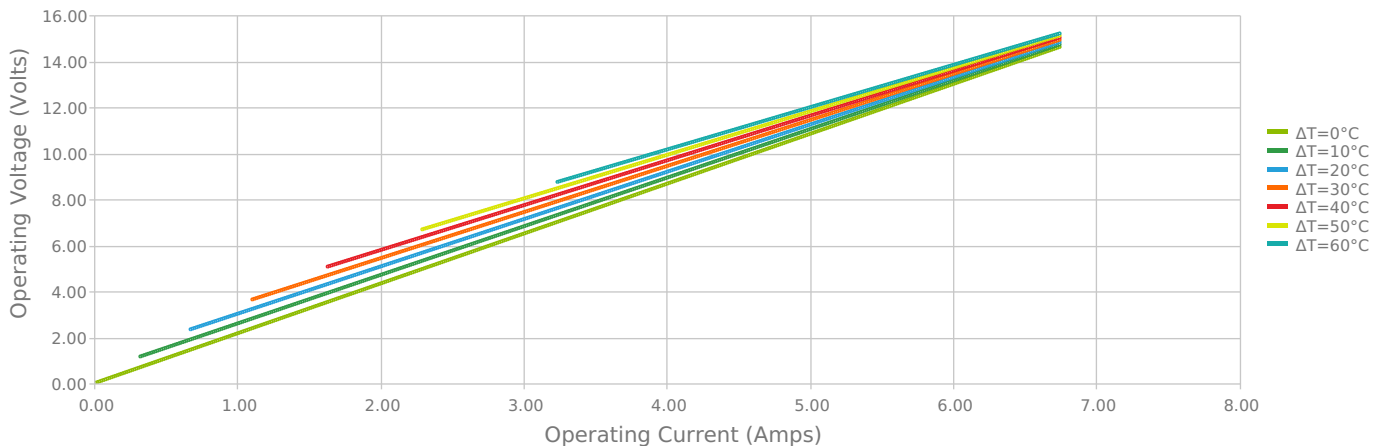
Heat Pumped at Cold Side  
 $T_{hot} = 27\text{ °C}$



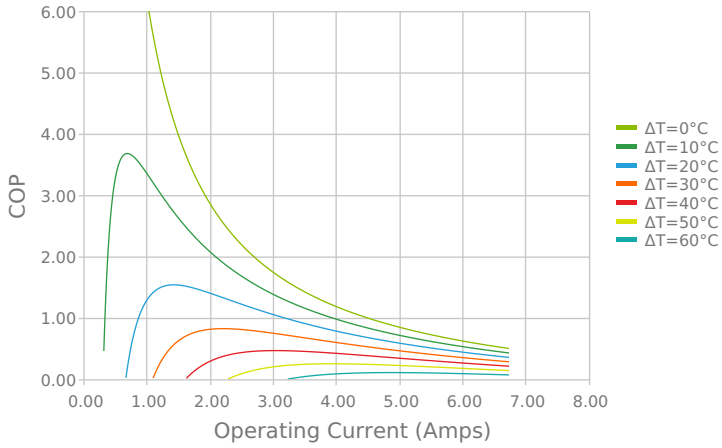
Heat Pumped at Cold Side  
 $T_{hot} = 27\text{ °C}$



Current vs Voltage (I vs V)  
 $T_{hot} = 27\text{ °C}$



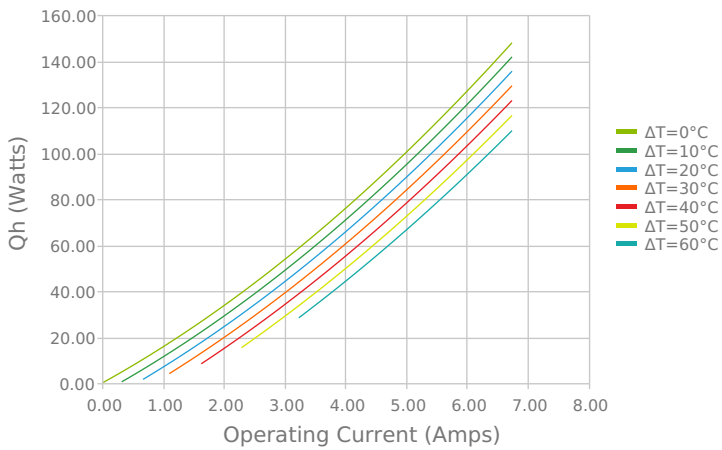
Coefficient of Performance (COP = Qc/Pin)  
 Thot = 27 °C



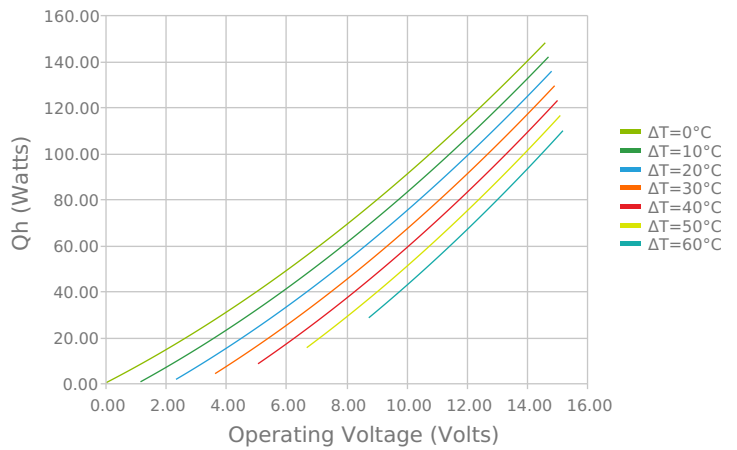
Coefficient of Performance (COP = Qc/Pin)  
 Thot = 27 °C



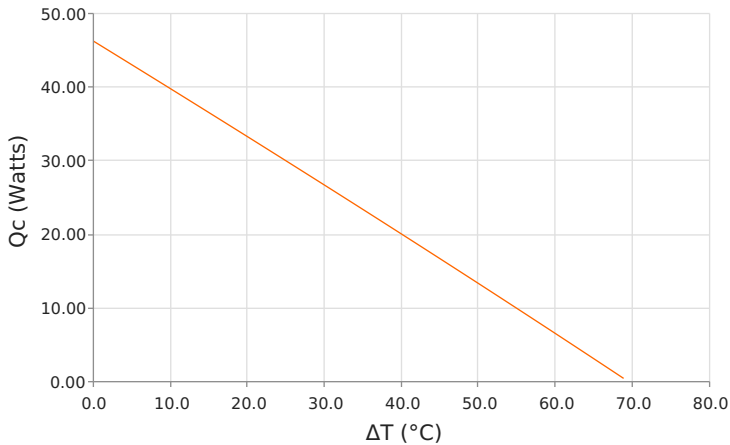
Total Heat Dissipated at Hot Side (Qh=Qc+Pin)  
 Thot = 27 °C



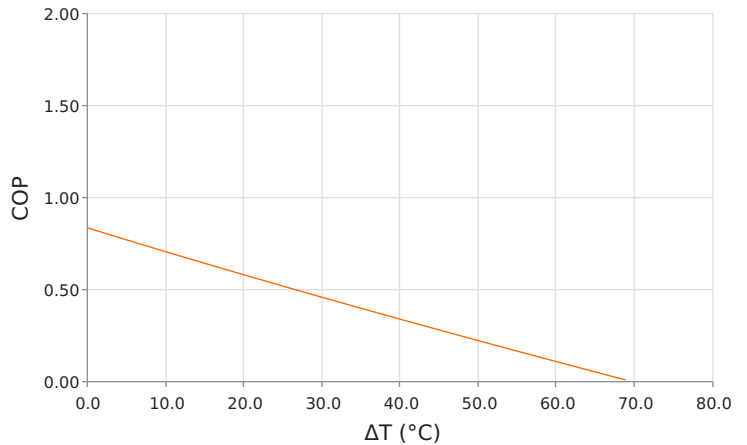
Total Heat Dissipated at Hot Side (Qh=Qc+Pin)  
 Thot = 27 °C



Heat Pumped at Cold Side (Qc)  
 Thot = 27 °C | Current = 5.1 Amps



Coefficient of Performance (COP = Qc/Pin)  
 Thot = 27 °C | Current = 5.1 Amps



## SPECIFICATIONS\*

| Hot Side Temperature                                      | 27.0 °C      | 35.0 °C    | 50.0 °C    |
|---|--------------|------------|------------|
| <b>Qcmax (<math>\Delta T = 0</math>)</b>                  | 49.3 Watts   | 50.8 Watts | 53.5 Watts |
| <b><math>\Delta T_{max}</math> (<math>Q_c = 0</math>)</b> | 70.5°C       | 73.5°C     | 78.8°C     |
| <b>I<sub>max</sub> (I @ <math>\Delta T_{max}</math>)</b>  | 6.0 Amps     | 5.9 Amps   | 5.9 Amps   |
| <b>V<sub>max</sub> (V @ <math>\Delta T_{max}</math>)</b>  | 13.9 Volts   | 14.4 Volts | 15.4 Volts |
| <b>Module Resistance</b>                                  | 2.17 Ohms    | 2.26 Ohms  | 2.43 Ohms  |
| <b>Max Operating Temperature</b>                          | 80 °C        |            |            |
| <b>Weight</b>   | 21.0 gram(s) |            |            |

\* Specifications reflect thermoelectric coefficients updated March 2020

## FINISHING OPTIONS

| Suffix | Thickness                            | Flatness / Parallelism                     | Hot Face | Cold Face | Lead Length         |
|--------|--------------------------------------|--|----------|-----------|---------------------|
| L1     | 3.810 ±0.025 mm<br>0.150 ± 0.0010 in | 0.025 mm / 0.025 mm<br>0.001 in / 0.001 in | Lapped   | Lapped    | 114.3 mm<br>4.50 in |

## SEALING OPTIONS

| Suffix | Sealant | Color | Temp Range | Description          |
|--------|---------|-------|------------|----------------------|
|        | None    |       |            | No sealing specified |

## NOTES

1. Max operating temperature: 80°C
2. Do not exceed I<sub>max</sub> or V<sub>max</sub> when operating module
3. Reference assembly guidelines for recommended installation
4. Solder tinning also available on metallized ceramics

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Date: 12/14/2021